IPC  ASSOCIATION CON ELECTRONICS IND	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bot international and Pan-American copyright conventions.		der both This docum level parts,	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi				ials and Mfg Information				
upplier In	formation							,						
Company name*			Company un	Company unique ID			Unique ID Authority				Response Date*			
nsemi						1				2024-05-11				
Contact Name	2		Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
uthorized Re	epresentative*		Title - Representative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Re	equester Item Number	Mfr Item	Number	Mfr Item Name		Effective Da	te Version	ı	Manufacturing Site	We	eight*	UOM	Unit Type	
				High Perf Current N with Integrated HV	Mode Resonant Controller Drivers	· 2024-05-11 TH6		ГН6	133	2.3281	mg	Each		
Ianufactu	ring Proccess Informa	ntion												
2		erminal Base Alloy J-STD-020 MSL Rat		STD-020 MSL Rating			re Max Time at Peak	Temperatur	e Number	r of Reflow Cyc	eles			
Matte Tin (Sn) - annealed CU A		U Alloy 3		260   C   30		seconds	3							
omments														
<b>ITENTION</b>	: MSL 3 Rated item require	es Bake and D	ry Pack (after	r electrical test)										
or more info	rmation regarding material	l composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appl											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.6562	mg	Supplier	Silicon (Si)	7440-21-3		0.6562	mg
Die Attach	0.875	mg		Epoxy resin	proprietary data		0.0437	mg
			Supplier	4-Methylhexahydrophthalsureanhydrid	19438-60-9		0.0044	mg
			Supplier	Titanium triisostearoylisopropoxide	61417-49-0		0.0437	mg
			Supplier	2,2-dimethyl-1,3-propanediyl dimethacrylate	1985-51-9		0.0437	mg
			Supplier	2-(3,4- Epoxycyclohexyl)ethyltrimethoxysilane	3388-04-3		0.0437	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.0044	mg
			Supplier	1,4-Bis(2,3-epoxypropoxy)butane	2425-79-8		0.0437	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0437	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.6037	mg
Lead Frame	43.7501	mg	Supplier	Silver (Ag)	7440-22-4		0.105	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0831	mg
			Supplier	Iron (Fe)	7439-89-6		1.1331	mg
			Supplier	Copper (Cu)	7440-50-8		42.3676	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0613	mg
Mold Compound-Black	84.2031	mg		Epoxy resin	proprietary data		8.8834	mg
			Supplier	Phenolic Resin	Proprietary Data		2.5261	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.5261	mg
			Supplier	Carbon Black (C)	1333-86-4		0.421	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		69.8465	mg
Plating	2.2031	mg	Supplier	Tin (Sn)	7440-31-5		2.2031	mg
Wire Bond	0.6406	mg	Supplier	Palladium (Pd)	7440-05-3		0.0128	mg
			Supplier	Gold (Au)	7440-57-5		0.0032	mg
			Supplier	Copper (Cu)	7440-50-8		0.6246	mg